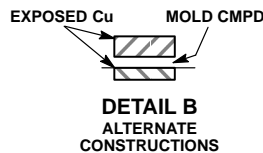
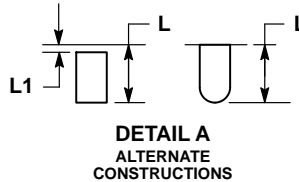
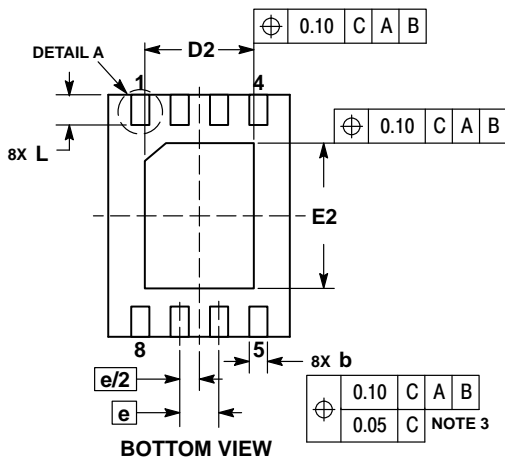
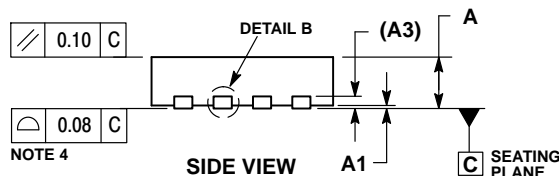
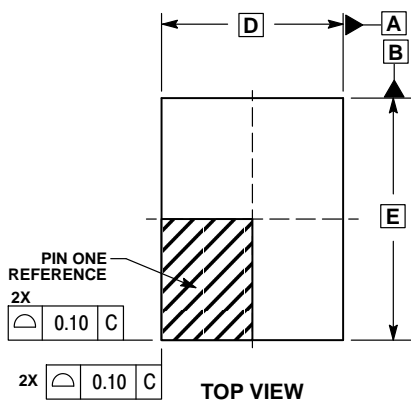


SCALE 2:1

**WDFN8 3x4, 0.65P**  
CASE 509AF  
ISSUE C

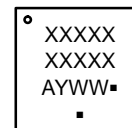
DATE 06 MAY 2014



## NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM THE TERMINAL TIP.
4. PROFILE TOLERANCE APPLIES TO THE EXPOSED PAD AS WELL AS THE LEADS.

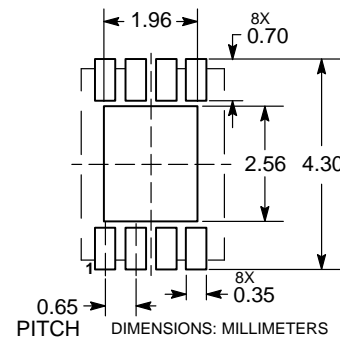
MILLIMETERS		
DIM	MIN	MAX
A	—	0.80
A1	0.00	0.05
A3	0.20	REF
b	0.20	0.30
D	3.00	BSC
D2	1.70	1.90
E	4.00	BSC
E2	2.30	2.50
e	0.65	BSC
L	0.45	0.55
L1	—	0.10

**GENERIC  
MARKING DIAGRAM\***


A = Assembly Location  
Y = Year  
WW = Work Week  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

**RECOMMENDED  
SOLDERING FOOTPRINT\***


\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<b>DESCRIPTION:</b>	<b>WDFN8 3X4, 0.65P</b>	<b>PAGE 1 OF 1</b>

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